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March 2015

## MTD3055VL

### N-Channel Logic Level Enhancement Mode Field Effect Transistor

#### **General Description**

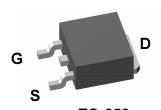
This N-Channel Logic Level MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

These MOSFETs feature faster switching and lower gate charge than other MOSFETs with comparable  $\rm R_{\rm DS(ON)}$  specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.

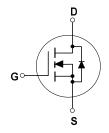
#### **Features**

- 12 A, 60 V.  $R_{DS(ON)} = 0.18 \Omega @ V_{GS} = 5 V$
- Critical DC electrical parameters specified at elevated temperature.
- Low drive requirements allowing operation directly from logic drivers. Vgs(th) < 2 V.</li>
- Rugged internal source-drain diode can eliminate the need for an external Zener diode transient suppressor.
- 175°C maximum junction temperature rating.



TO-252

Absolute Maximum Ratings Tc=25°C unless otherwise noted



Symbol	Parameter	Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage	60	V
V <sub>GSS</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub>	Maximum Drain Current -Continuous (Note 1)	12	Α
	T <sub>C</sub> = 100°C (Note 1)	8	1
	Maximum Drain Current -Pulsed	42	1
P <sub>D</sub>	Maximum Power Dissipation @ $T_c = 25^{\circ}C$ (Note 1)	48	W
	$T_A = 25^{\circ}C$ (Note 1a)	3.9	1
	$T_A = 25$ °C (Note 1b)	1.5	1
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to +175	∘c

# Thermal Characteristics R. D. Thermal Resistance, Junction-to- Case (Note 1)

R <sub>eJC</sub>	Thermal Resistance, Junction-to- Case	(Note 1)	3.13	∘C/W
R <sub>eJA</sub>	Thermal Resistance, Junction-to- Ambient	(Note 1a)	71.4	∘C/W
•				

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
MTD3055VL	MTD3055VL	13"	16mm	2500

<sup>\*</sup> Die and manufacturing source subject to change without prior notification.

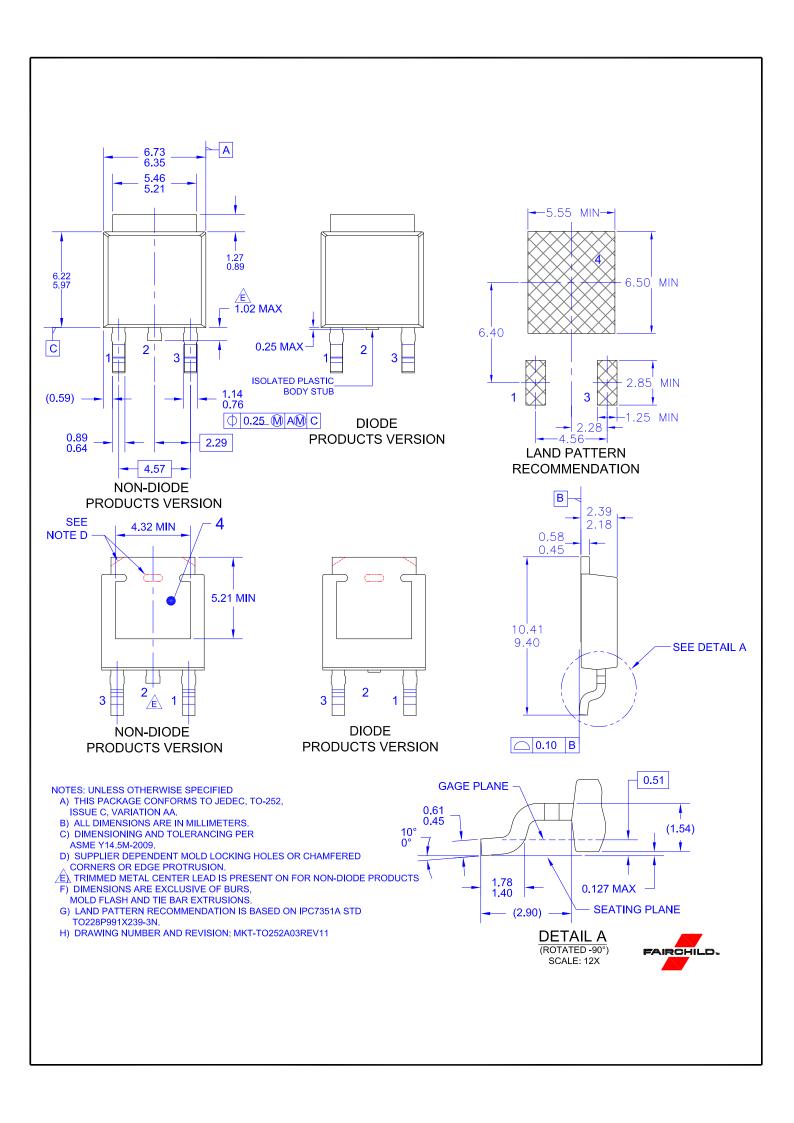
©1999 Fairchild Semiconductor Corporation MTD3055VL Rev. 1.1

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
DRAIN-S	OURCE AVALANCHE RATI	NGS (Note 2)				!
W <sub>DSS</sub>	Single Pulse Drain-Source Avalanche Energy	V <sub>DD</sub> = 25 V, I <sub>D</sub> = 12 A			72	mJ
I <sub>AR</sub>	Maximum Drain-Source Avalanche	Current			12	Α
Off Chara	acteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	60			V
$\frac{\Delta BV_DSS}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 <sub>μ</sub> A, Referenced to 25∘C		54		mV/∘C
IDSS	Zero Gate Voltage Drain Current $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$				10	μΑ
		V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150∘C			100	
GSSF	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 15 V, V <sub>DS</sub> = 0 V			100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = -15 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Chara	acteristics (Note 2)					
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250  \mu A$	1	1.5	2	V
$\frac{\Delta V^{\text{GS(th)}}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, Referenced to 25°C		-2.6		mV/∘C
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	$V_{GS} = 5 V, I_{D} = 6 A,$			0.18	Ω
$V_{DS(on)}$	Drain-Source On-Voltage On-Resistance	V <sub>GS</sub> = 5 V, I <sub>D</sub> = 12 A I <sub>D</sub> = 6 A, T <sub>J</sub> =150∘C			2.6 2.5	V
<b>g</b> <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 8 V, I <sub>D</sub> = 6 A	5.0			S
<u>Dynamic</u>	Characteristics				-	
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$			570	pF
$C_{oss}$	Output Capacitance	f = 1.0 MHz			160	pF
C <sub>rss</sub>	Reverse Transfer Capacitance				40	pF
Switching	g Characteristics (Note 2)				•	•
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 12 A,			20	ns
tr	Turn-On Rise Time	$V_{GS} = 5 \text{ V}, R_{GEN} = 9.1 \Omega$			190	ns
t <sub>d(off)</sub>	Turn-Off Delay Time				30	ns
t <sub>f</sub>	Turn-Off Fall Time				90	ns
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = 48 V,			10	nC
$Q_{gs}$	Gate-Source Charge	I <sub>D</sub> = 12 A, V <sub>GS</sub> = 5 V		2		nC
Q <sub>gd</sub>	Gate-Drain Charge			6.1		nC
	urce Diode Characteristics	and Maximum Ratings	•		•	•
Is	Maximum Continuous Drain-Sourc				12	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Did	ode Forward Current (Note 2)			42	Α
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \ V_1  _{S} = 12 \ A$ (Note 2)			1.3	٧
t <sub>rr</sub>	Drain-Source Reverse Recovery Time	l <sub>F</sub> = 12 A, di/dt = 100A/μs		51		nS

<sup>.</sup>  $R_{\rm BJA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance whe  $R_{\rm BJC}$  is guaranteed by design while  $R_{\rm BCA}$  is determined by the user's board design.



Scale 1 : 1 on letter size paper
2. Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2.0%



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